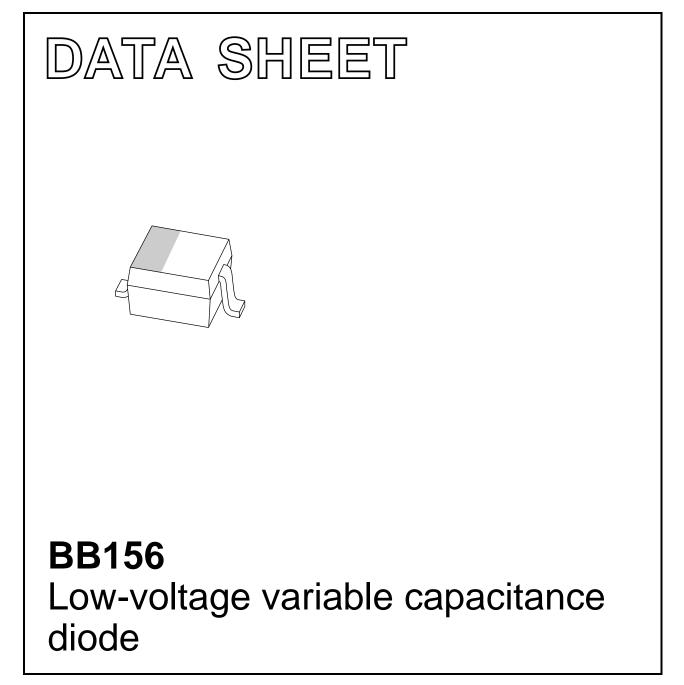
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1998 Aug 17 2004 Mar 01



BB156

FEATURES

- Excellent linearity
- Very small plastic SMD package
- C7.5: 4.8 pF; ratio 3.3
- Very low series resistance.

APPLICATIONS

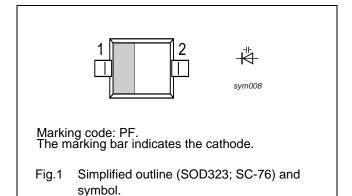
• Voltage controlled oscillators (VCO).

DESCRIPTION

The BB156 is a planar technology variable capacitance diode, in a SOD323 very small plastic SMD package.

PINNING

PIN	DESCRIPTION	
1	cathode	
2	anode	



ORDERING INFORMATION

TYPE NUMBER		PACKAGE		
ITPE NUMBER	NAME	DESCRIPTION	VERSION	
BB156 –		plastic surface mounted package; 2 leads	SOD323	

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V _R	continuous reverse voltage	-	10	V
I _F	continuous forward current	_	20	mA
T _{stg}	storage temperature	-55	+150	°C
Tj	operating junction temperature	-55	+125	°C

BB156

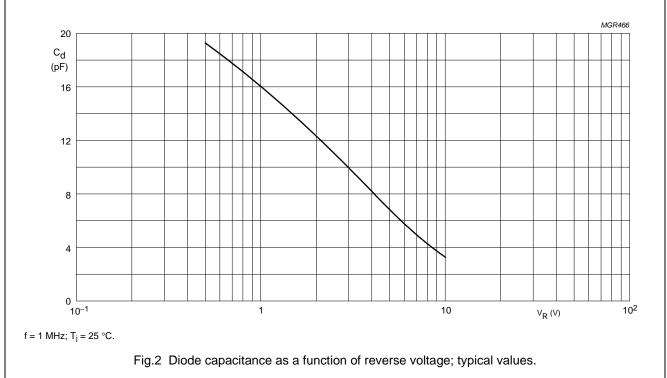
ELECTRICAL CHARACTERISTICS

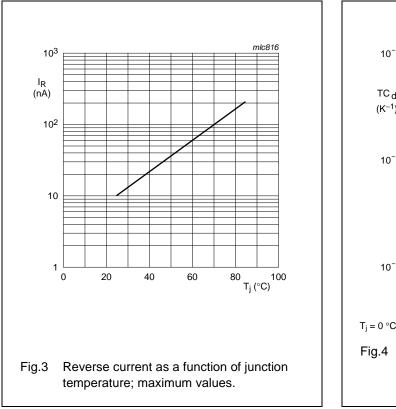
 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

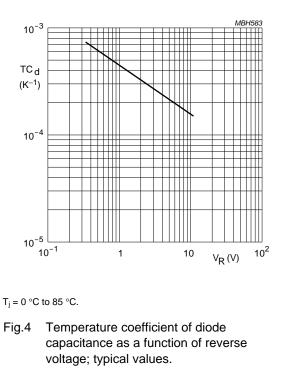
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _R	reverse current	V _R = 10 V; see Fig.3	-	-	10	nA
		V_R = 10 V; T _j = 85 °C; see Fig.3	_	-	200	nA
r _s	diode series resistance	f = 470 MHz; C _d = 9 pF	_	0.4	0.7	Ω
C _d	diode capacitance	f = 1 MHz; see Figs 2 and 4				
		$V_R = 1 V$	14.4	16	17.6	pF
		$V_R = 4 V$	7.6	8.6	9.6	pF
		V _R = 7.5 V	4.2	4.8	5.4	pF
$\frac{C_{d (1 V)}}{C_{d (7.5 V)}}$	capacitance ratio	f = 1 MHz	2.7	3.3	3.9	

NXP Semiconductors

Low-voltage variable capacitance diode

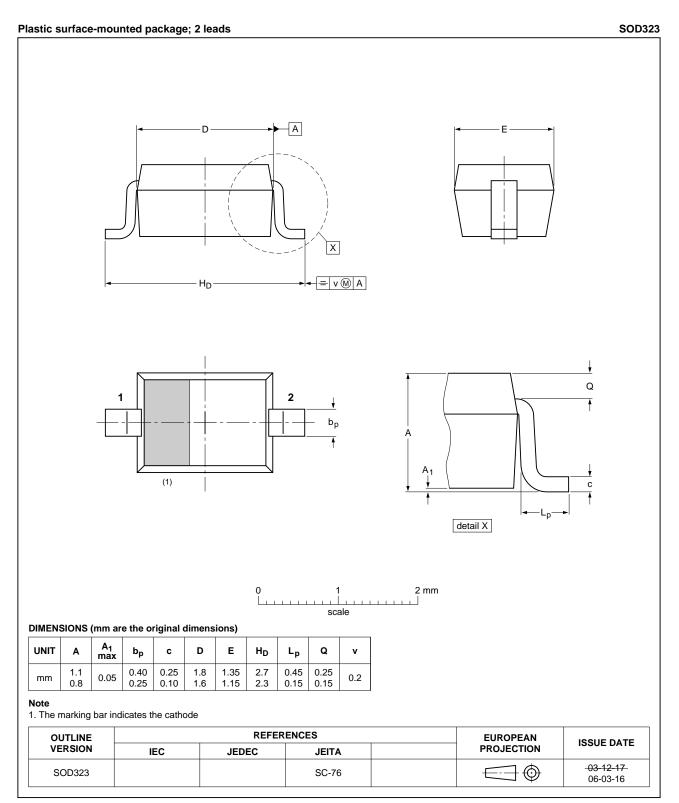






BB156

PACKAGE OUTLINE



BB156

BB156

DATA SHEET STATUS

DOCUMENT STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITION
Objective data sheet	Development	This document contains data from the objective specification for product development.
Preliminary data sheet	Qualification	This document contains data from the preliminary specification.
Product data sheet	Production	This document contains the product specification.

Notes

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Customer notification

This data sheet was changed to reflect the new company name NXP Semiconductors, including new legal definitions and disclaimers. No changes were made to the technical content, except for package outline drawings which were updated to the latest version.

Contact information

For additional information please visit: http://www.nxp.com For sales offices addresses send e-mail to: salesaddresses@nxp.com

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